

# Android Things & NXP

NXP FAE

2018, JAN 22



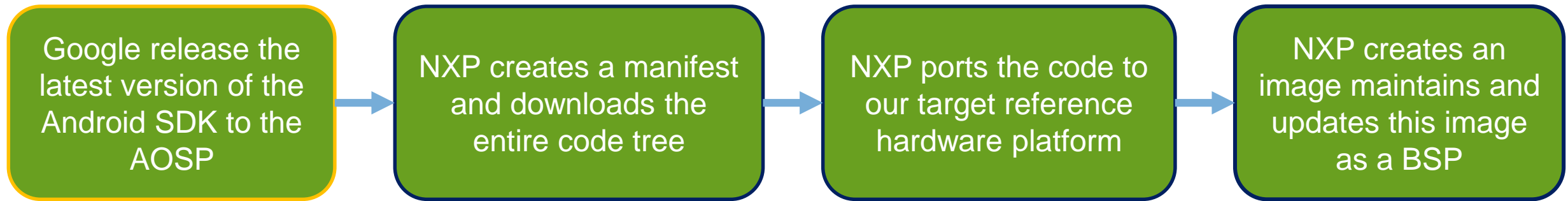
EXTERNAL USE



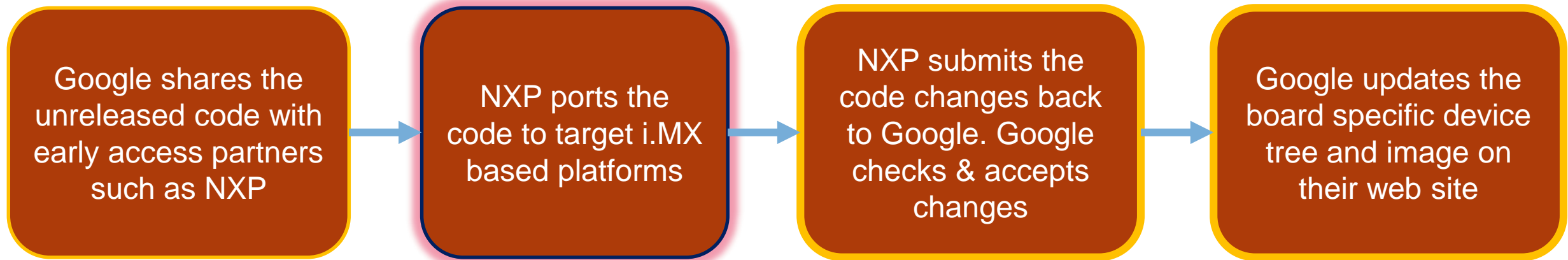
SECURE CONNECTIONS  
FOR A SMARTER WORLD

# Google & NXP

## Android



## Android Things



# Agenda

- ❑ **Development boards with NXP SOC**s
- ❑ Best SOC for Android Things
- ❑ Demo on setup development board
- ❑ Q & A



android  
things



# NXP and Partner board offering

- Based on two processors

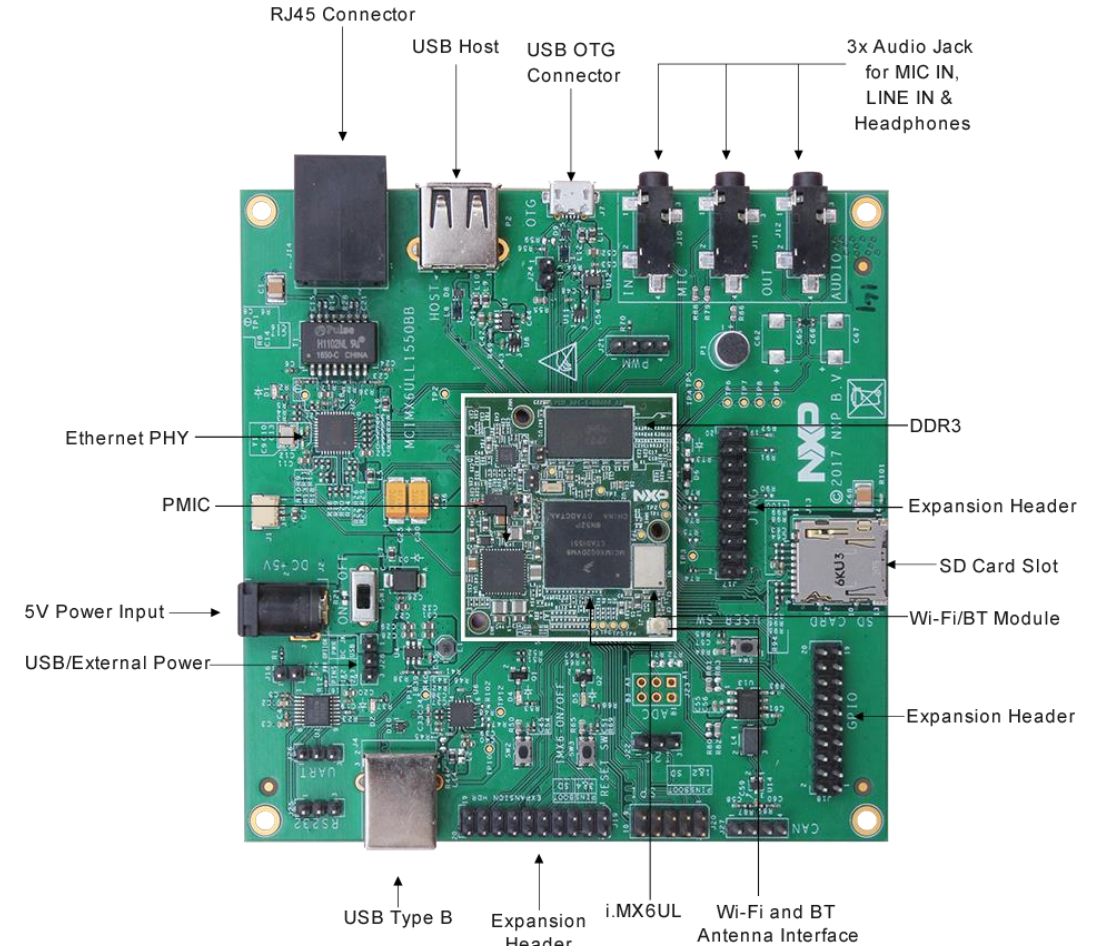
- i.MX7D

- i.MX6UL

- Two partners

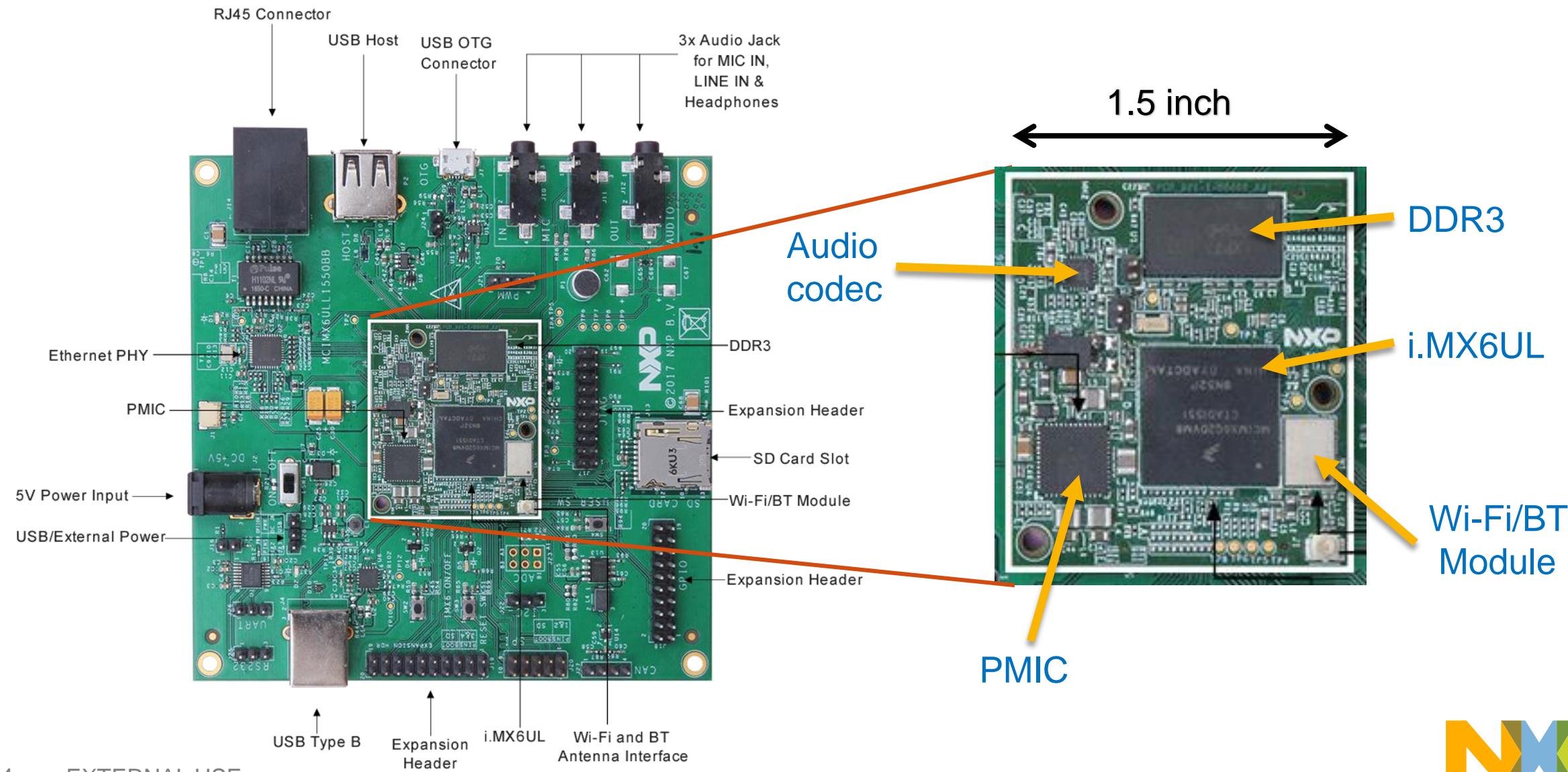
- Technexion

- VVDN Tech





# Prototype to Production...System On Module



# Pico i.MX6UL and 7Dual

## SOM Key Features:

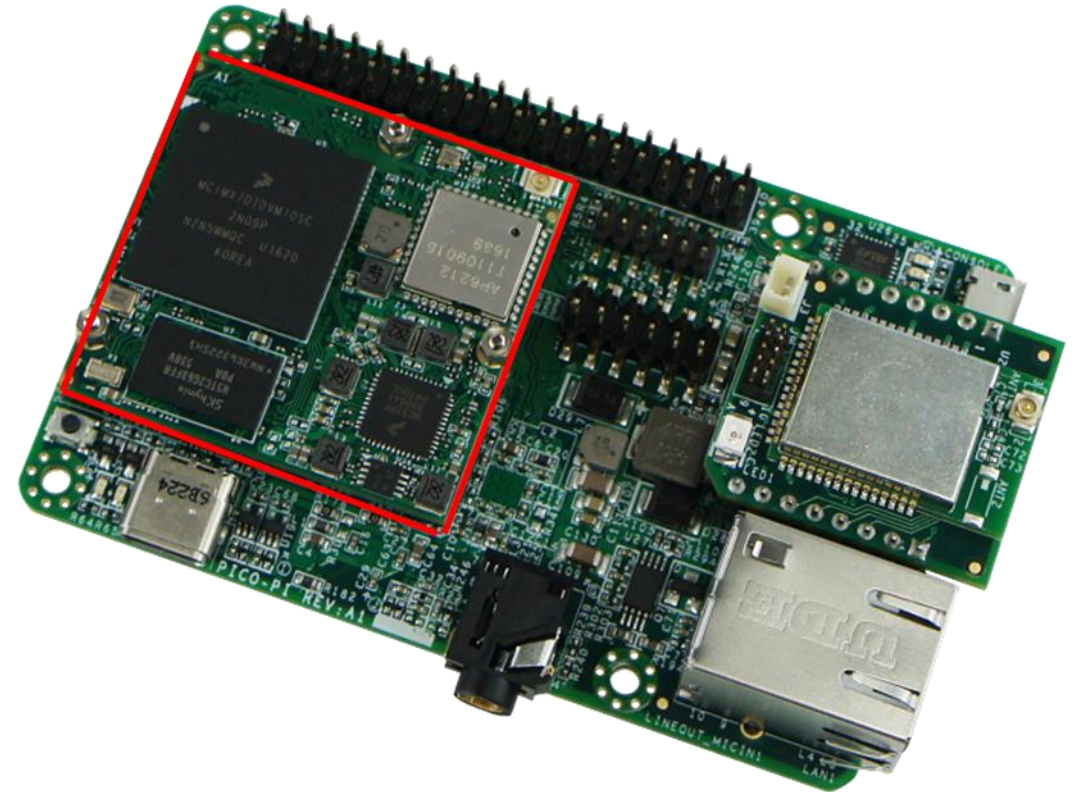
- i.MX6UL/7D
- Memory: 512MB DDR3L
- Onboard Storage: 4GB
- Wi-Fi: 802.11n (6UL) 802.11 ac (7D) BT 4.1
- PMIC NXP PF3000

## Base Board:

- Focused on Raspberry Pi form factor & interfaces
- Low cost platforms (\$65 & 75)

## Availability:

- [TechNexion.com](https://www.TechNexion.com)
- [Digikey](https://www.digikey.com)
- [Mouser](https://www.mouser.com)





# NXP Certified Partner Boards –Argon i.MX6UL

## SOM Key Features:

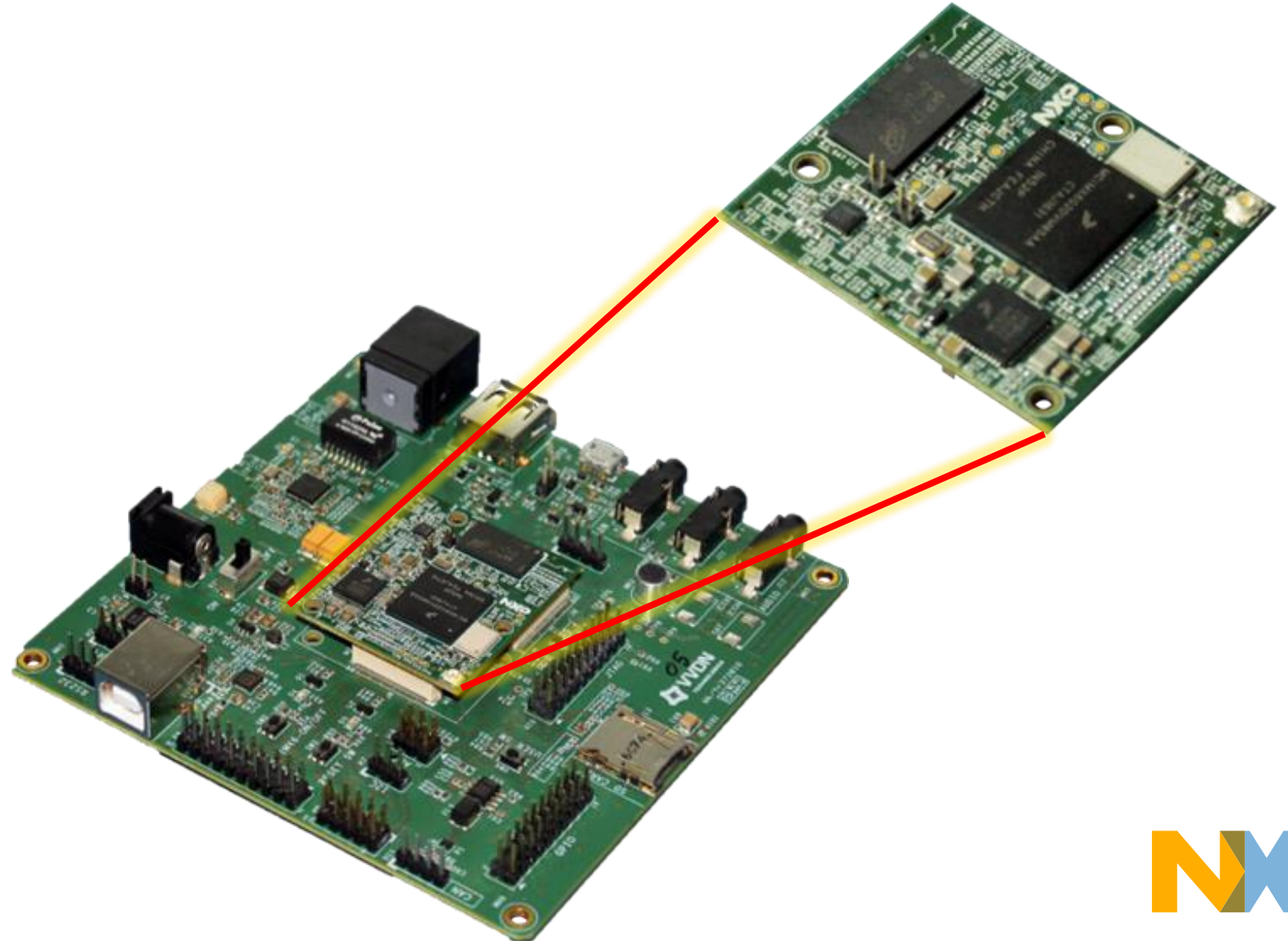
- i.MX6UL
- Memory: 512MB DDR3L
- Onboard Storage: 4GB
- Wi-Fi: 802.11n
- PMIC NXP PF3000

## Base Board:

- 3 Expansion connectors
- 3 x Audio Jack
- USB Host, OTG, type B
- SD Card slot
- \$65

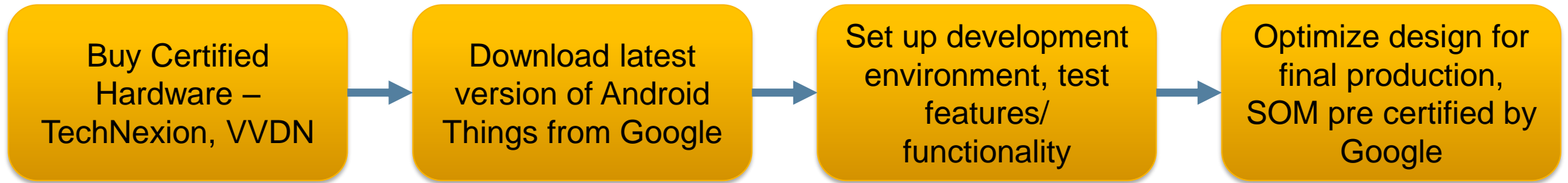
## Availability:

- [Argonboard.com](http://Argonboard.com)

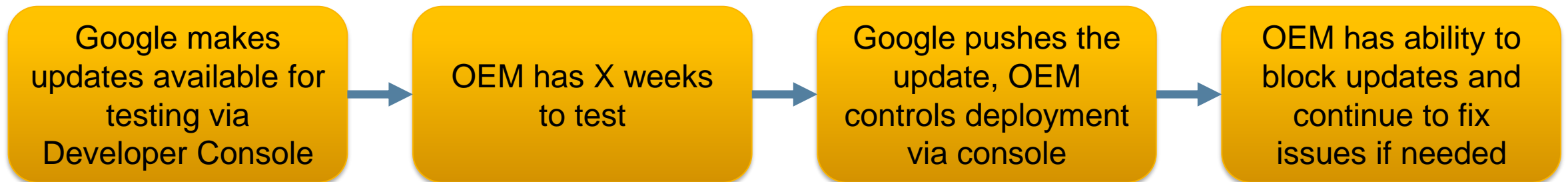


# Engagement Model

## Development



## Management





# NXP offering – Key Customer Advantages



## Certified Hardware

Prototype devices on certified hardware, quickly test features/functionality.

NXP based SOM's include memory, PMIC, WiFi/BT module.



## Time to market

Decrease development and time to production.

- Certified, production ready SOM's.
- Driver, HAL, firmware integrated & production ready.



## Build to Scale

Work with NXP/Partners directly to scale volume & optimize board design.

Devices run on a proven and production ready platform



## Google Services

Take advantage of the Android ecosystem:

- Google managed updates
- Android GMS services
- Google Cloud platform
- Assistant & Chromecast

# Android Things Useful Links

- NXP web pages: <http://www.nxp.com/AndroidThings>
- Android Things Developer site <https://developer.android.com/things/index.html>
- G+ Android Things community [g.co/iotdev](https://plus.google.com/communities/105114100000000000000)
- Argon board landing page <http://www.argonboards.com/Argon-imx6UL-SOM.php>
- TechNexion landing page: <http://www.technexion.com/solutions/iot-development-platform/android-things/>
- Murata landing page: <http://wireless.murata.com/eng/products/wireless-connectivity-platforms/iot-system-on-module.html>

## Blog posts:

- <https://blog.nxp.com/iot/android-things-adds-i-mx-7dual-and-google-voice-assistant-support>
- <https://android-developers.googleblog.com/2017/05/android-things-developer-preview-4.html>

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things



# i.MX Processor Roadmap

Two New i.MX Platforms Based on 28nm FD SOI Technology

i.MX 6QuadPlus



i.MX 6Quad



i.MX 6DualPlus



i.MX 6Dual



i.MX 6DualLite



i.MX 6Solo



i.MX 6SoloX



i.MX 6SoloLite



i.MX 6UltraLite

ARM® v7-A



## i.MX 8 series

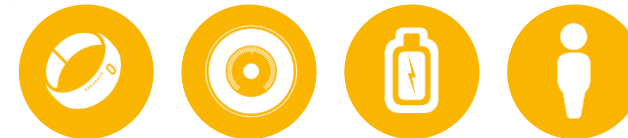
Advanced Graphics & Performance

ARM® v8-A

## i.MX 7 series

Power Efficiency

ARM® v7-A







## i.MX 7Solo

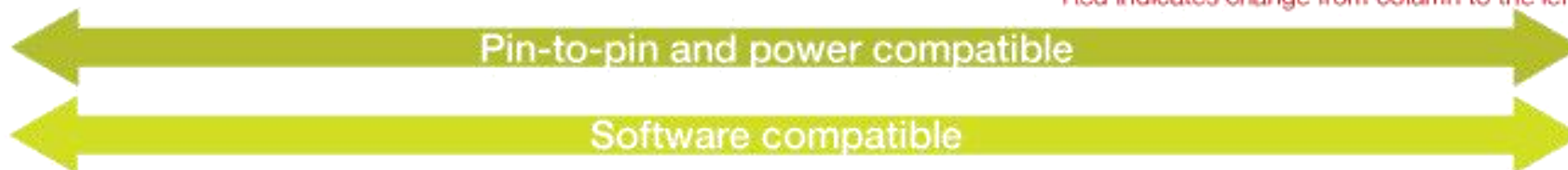
- Single ARM® Cortex®-A7 up to 800 MHz
- Cortex-M4 up to 200 MHz
- 512KB L2 cache
- 16/32-bit DDR3/DDR3L and LPDDR2/3 at 533 MHz
- Single Gigabit Ethernet (AVB)
- Full security with tamper resist



## i.MX 7Dual

- **Dual** ARM® Cortex®-A7 up to **1.0** GHz
- Cortex-M4 up to 200 MHz
- 512 KB L2 cache
- 16/32-bit DDR3/DDR3L and LPDDR2/3 at 533 MHz
- **Dual** Gigabit Ethernet (AVB)
- Full security with tamper resist
- **EPD controller**
- **PCIe (x1 lane)**

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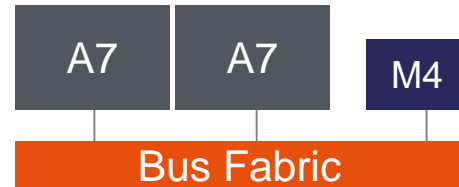
Consumer



Extended  
Consumer

## Advanced Heterogeneous Architecture

- Up to Dual Cortex-A7 @ 1GHz
- Cortex-M4 @ 200MHz
  - Offload Tasks
  - Optimize Power
  - Increase Security



## Unmatched Power Efficiency

- 3x improvement in Power Efficiency vs i.MX 6
- 100  $\mu$ W/MHz for Cortex-A7
- 70  $\mu$ W/MHz for Cortex-M4
- One third the power consumed in the Low Power suspend mode (250 $\mu$ W) vs i.MX 6



## Enabling Flexible High Speed Connectivity

- PCI-e v2.1
- Dual Gbit Ethernet with AVB
- DDR QuadSPI support
- eMMC 5.0



## Complete Security Infrastructure

- Secure Boot
- Crypto H/W Acceleration
- Internal and External Tamper Detection
- Secure RAM
- DPA attack Resistance
- Secure JTAG



# Market Challenges Addressed by i.MX 7 series

- Achieving longer battery life
- Addressing system security needed in IoT systems
- Integrating memory standards which produce best performance and cost
- Maintaining latest high speed connectivity standards
- Achieving small form factors for space constrained applications
- Supporting the latest EPD technology



# i.MX 7Dual/Solo Family Target Applications

## MOBILE DEVICES

### LPDDR2/3 Small Package



- Healthcare / Patient Monitoring
- HMI Control / Security
- Point of Sale
- Printing
- Home Control
- Wearables
- eReaders
- General Embedded Control
- Embedded Board Solutions
- IoT

## CONNECTED DEVICES

### Low Cost DDR3 Larger Pitch Package





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